# **ESD Protection Diode Array**

# Quad, Low Clamping Voltage

This quad monolithic silicon overvoltage suppressor is designed for applications requiring transient voltage protection capability. It is intended for use in ESD sensitive equipment such as computers, printers, cell phones, medical equipment, and other applications. Its quad junction common anode design protects four separate lines using only one package. These devices are ideal for situations where board space is at a premium.

## **Specification Features**

- SC-88A Package Allows Four Separate Unidirectional Configurations
- Low Leakage  $< 5 \,\mu A @ 5 V$
- Breakdown Voltage: 6.1 V 7.2 V @ 1 mA
- Low Capacitance (90 pF TYP)
- Provides Protection for IEC61000-4-2
- Pb-Free Packages are Available\*

#### Mechanical Characteristics

- Void Free, Transfer-Molded, Thermosetting Plastic Case
- Corrosion Resistant Finish, Easily Solderable
- Package Designed for Optimal Automated Board Assembly
- Small Package Size for High Density Applications

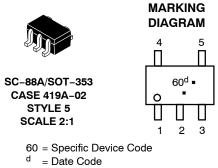
#### Applications

- Computers
- Printers
- Cell Phones
- Medical Equipment



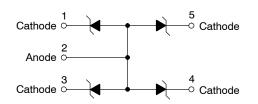
# **ON Semiconductor®**

#### www.onsemi.com



= Pb–Free Package

(Note: Microdot may be in either location)



# **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
SMF05T1	SC-88A	3000 Tape & Reel
SMF05T1G	SC-88A (Pb-Free)	3000 Tape & Reel
SMF05T2G	SC–88A (Pb–Free)	3000 Tape & Reel
SMF05CT1	SC-88A	3000 Tape & Reel
SMF05CT1G	SC-88A (Pb-Free)	3000 Tape & Reel
SMF05CT2	SC-88A	3000 Tape & Reel
SMF05CT2G	SC-88A (Pb-Free)	3000 Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

## **MAXIMUM RATINGS** (T<sub>A</sub> = $25^{\circ}$ C unless otherwise noted)

	Characteristic	Symbol	Value	Unit
Peak Power Dissipation @ 8 X 20 $\mu s$ @T_A $\leq$ 25°C (Note 1)		P <sub>pk</sub>	200	W
Maximum Junction Temperature		T <sub>Jmax</sub>	150	°C
Operating Junction and Storage Temperature Range		T <sub>J,</sub> T <sub>stg</sub>	–55 to +150	°C
ESD Discharge	IEC61000–4–2, Air Discharge IEC61000–4–2, Contact Discharge	V <sub>PP</sub>	16 9	kV
Lead Solder Temperature (10 seconds duration)		ΤL	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

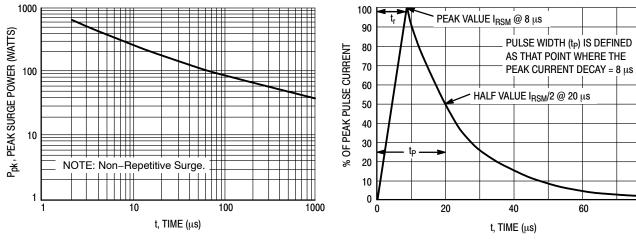
1. Non-repetitive current per Figure 2. Derate per Figure 3.

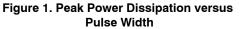
**ELECTRICAL CHARACTERISTICS** ( $T_A = 25^{\circ}C$  unless otherwise noted)

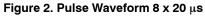
	Breakdown Voltage V <sub>BR</sub> @ 1 mA (Volts)		Leakage Current I <sub>R</sub> @ V <sub>RWM</sub> = 5 V	Capacitance @ 0 V Bias	Max V <sub>F</sub> @ I <sub>F</sub> = 200 mA	Max Clamping Voltage (V <sub>C</sub> ) @ I <sub>PP</sub>		Max Clamping Voltage (V <sub>C</sub> ) @ I <sub>PP</sub>	
Device	Min	Max	(μA)	(pF)	(V)	I <sub>PP</sub> (A)	V <sub>C</sub> (V)	I <sub>PP</sub> (A)	V <sub>C</sub> (V)
SMF05	6.0	7.2	5.0	90	1.25	1.0	9.5	12	12.5

# **TYPICAL PERFORMANCE CURVES**

(T<sub>A</sub> =  $25^{\circ}$ C unless otherwise noted)





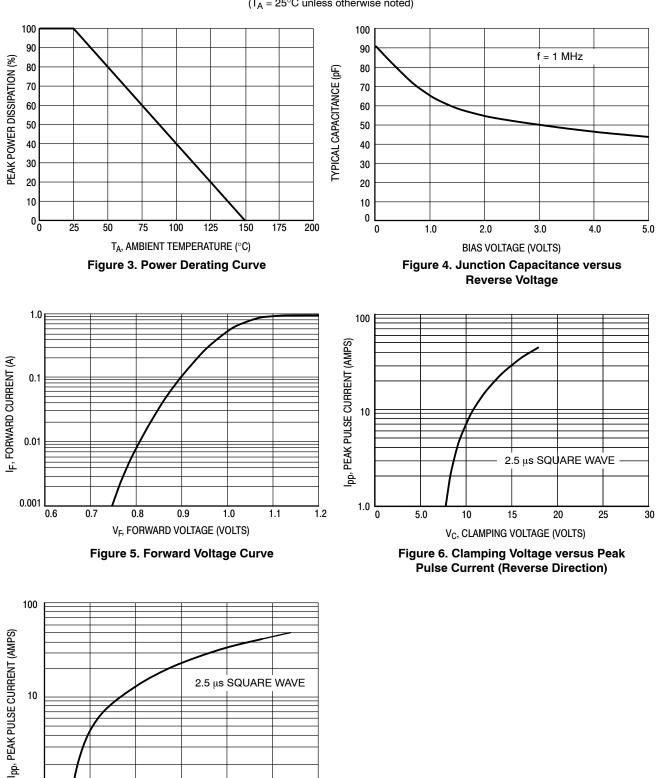


80

# SMF05

# **TYPICAL PERFORMANCE CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 



6.0 V<sub>C</sub>, FORWARD CLAMPING VOLTAGE (VOLTS)

8.0

10

4.0

1.0

0

2.0

Figure 7. Clamping Voltage versus Peak **Pulse Current (Forward Direction)** 

12

# **NSEM**



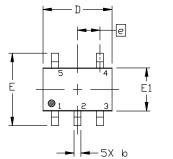
#### SC-88A (SC-70-5/SOT-353) CASE 419A-02 **ISSUE M**

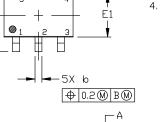
NDTES: 1.

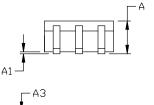
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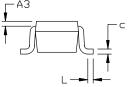
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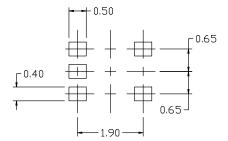
DATE 11 APR 2023











#### RECOMMENDED MOUNTING FOOTPRINT

For additional information on our Pb-Free strategy and soldering details, please download the DN Semiconductor Soldering and Mounting Techniques Reference Manual, SDLDERRM/D.

DIM	MILLIMETERS			
MIU	MIN,	NDM.	MAX.	
A	0.80	0.95	1.10	
A1			0.10	
A3	0.20 REF			
b	0.10	0.20	0.30	
С	0.10		0.25	
D	1.80	2.00	5'50	
E	2.00	2.10	5'50	
E1	1.15	1.25	1.35	
e	0.65 BSC			
L	0.10	0.15	0.30	

DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH,

PROTRUSIONS, OR GATE BURRS.MOLD FLASH, PROTRUSIONS,

OR GATE BURRS SHALL NOT EXCEED 0.1016MM PER SIDE.

CONTROLLING DIMENSION: MILLIMETERS 419A-01 DBSOLETE, NEW STANDARD 419A-02

# **GENERIC MARKING**





\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

XXX = Specific Device Code

Μ = Date Code = Pb-Free Package

(Note: Microdot may be in either location)

STYLE 1: PIN 1. BASE 2. EMITTER 3. BASE 4. COLLECTOR 5. COLLECTOR	STYLE 2: PIN 1. ANODE 2. EMITTER 3. BASE 4. COLLECTOR 5. CATHODE	STYLE 3: PIN 1. ANODE 1 2. N/C 3. ANODE 2 4. CATHODE 2 5. CATHODE 1	STYLE 4: PIN 1. SOURCE 1 2. DRAIN 1/2 3. SOURCE 1 4. GATE 1 5. GATE 2	STYLE 5: PIN 1. CATHODE 2. COMMON ANOD 3. CATHODE 2 4. CATHODE 3 5. CATHODE 4	E
STYLE 6: PIN 1. EMITTER 2 2. BASE 2 3. EMITTER 1 4. COLLECTOR 5. COLLECTOR 2/BASE	STYLE 7: PIN 1. BASE 2. EMITTER 3. BASE 4. COLLECTOR 1 5. COLLECTOR	STYLE 8: PIN 1. CATHODE 2. COLLECTOR 3. N/C 4. BASE 5. EMITTER	STYLE 9: PIN 1. ANODE 2. CATHODE 3. ANODE 4. ANODE 5. ANODE	Note: Please refer to style callout. If style to out in the datasheet r datasheet pinout or p	ype is not called efer to the device
DOCUMENT NUMBER:	98ASB42984B			ot when accessed directly from when stamped "CONTROLLED (	
DESCRIPTION:	SC-88A (SC-70-5/SOT-353)				PAGE 1 OF 1

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